

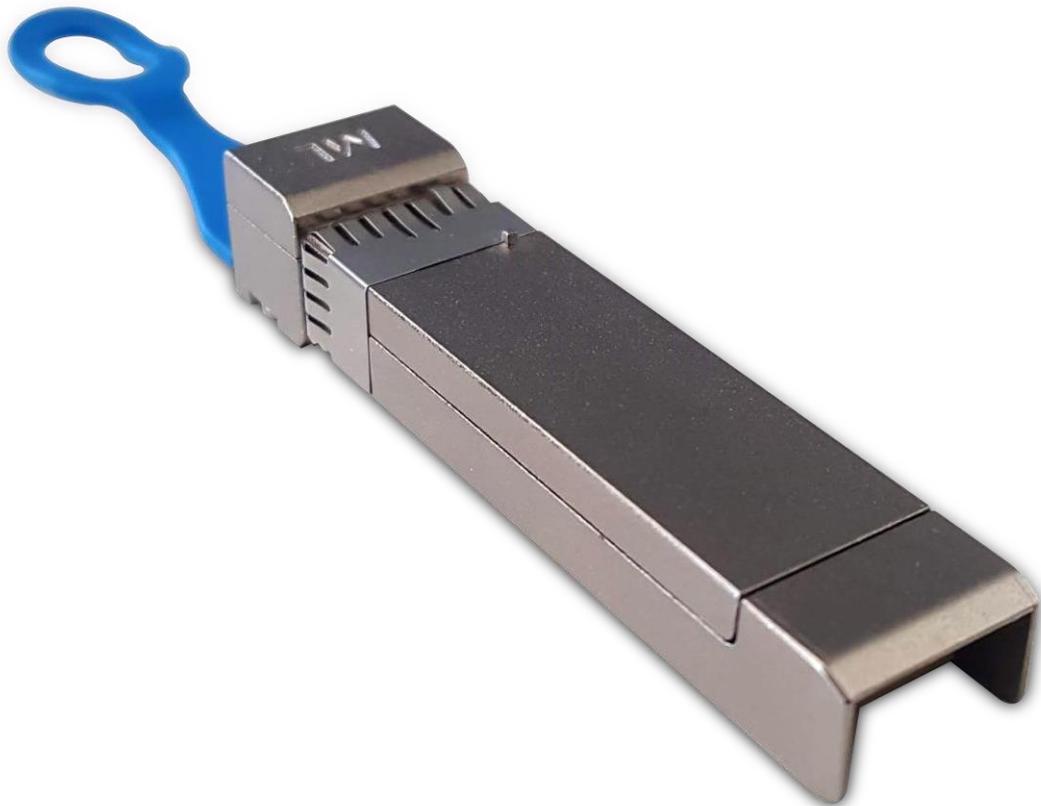
# ML4022- LB

MSA Compliant SFP-  
DD Electrical Passive

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Loopback

Rev 0.3



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## ML4022 Electrical Passive Loopback Interconnect - Key Features

- ✓ Power Consumption up to 4.32W by default, spread over 4 spots
- ✓ Population option to increase power to 4.96W
- ✓ Dual channels, supporting up to 28 Gbaud each (56Gbps)
- ✓ LED indicator
- ✓ Custom Memory Maps
- ✓ Temperature range from -40° to 125° C
- ✓ I2C Interface
- ✓ MSA Compliant EEPROM
- ✓ Voltage sense
- ✓ Temperature sense
- ✓ Insertion Counter
- ✓ Micro controller based

### ➤ LED Indicator

**Green** - Signifies that the module is fully plugged-in and operating in high power mode as defined by the SFP-DD MSA specification.

**Red** - Signifies the module is fully plugged-in and operating in low power mode as defined by the SFP-DD MSA specifications.

### ➤ Operating Conditions

Recommended Operation Conditions						
Parameter	Symbol	Notes/Conditions	Min	Typ	Max	Units
Operating Temperature	T <sub>A</sub>		0		80	°C
Supply Voltage	VCC	Main Supply Voltage	3.00	3.3	3.60	V
Data Rate	R <sub>b</sub>	Guaranteed to work at 56 Gbps	0		56	Gbps
Input/Output Load Resistance	RL	AC-Coupled, Differential	90	100	110	Ω
Power Class		Programmable to Emulate all power classes	0	-	4.96	W



Parameter	Symbol	Min	Max	Unit
<b>Clock Frequency</b>	$f_{SCL}$	0	400	kHz
<b>Clock Pulse Width Low</b>	$t_{LOW}$	1.3		us
<b>Clock Pulse Width High</b>	$t_{High}$	0.6		us
<b>Time bus free before new transmission can start</b>	$t_{BUF}$	20		us
<b>Input Rise Time (400kHz)</b>	$t_{R,400}$		300	ns
<b>Input Fall Time (400kHz)</b>	$t_{F,400}$		300	ns
<b>Serial Interface Clock Holdoff “Clock Stretching”</b>	$T_{\_clock\_hold}$		500	us

**Clock and Data Transitions:** The SDA pin is normally pulled high with an external device. Data on the SDA pin may change only during SCL low time periods. Data changes during SCL high periods indicate a START or STOP condition. All addresses and data words are serially transmitted to and from the SFP-DD in 8-bit words. Every byte on the SDA line must be 8-bits long. Data is transferred with the most significant bit (MSB) first.

**START Condition:** A high-to-low transition of SDA with SCL high is a START condition, which must precede any other command.

**STOP Condition:** A low-to-high transition of SDA with SCL high is a STOP condition.

**Acknowledge:** After sending each 8-bit word, the transmitter releases the SDA line for one bit time, during which the receiver is allowed to pull SDA low (zero) to acknowledge (ACK) that it has received each word. Device address bytes and write data bytes initiated by the host should be acknowledged by SFP-DD transceiver. Read data bytes transmitted by SFP-DD transceiver should be acknowledged by the host for all but the final byte read, for which the host should respond with a STOP instead of an ACK.

**Memory (Management Interface) Reset:** Synchronization issues may cause the master and slave to disagree on the specific bit location currently being transferred, the type of operation or even if an operation is in progress. The TWI protocol has no explicitly defined reset mechanism. The following procedure may force completion of the current operation and cause the slave to release SDA.

1. Clock up to 9 cycles
2. Look for SDA high in each cycle while SCL is high
3. If SFP-DD releases the bus, host is free to initiate a Start condition
4. If SDA remains low, TWI reset has failed

Device Addressing: SFP-DD devices require an 8-bit device address word following a start condition to enable a read or write operation. Data is transferred with the most significant bit (MSB) first.

The device address word consists of a mandatory sequence for the first seven most significant bits of device address (A0h). This is common to all SFP-DD devices.

The eighth bit of the device address is the read/write operation select bit. A read operation is initiated if this bit is set high and a write operation is initiated if this bit is set low.

## 2.3 I2C Read/Write Functionality

### 2.3.1 SFP-DD Memory Address Counter (Read AND Write Operations)

SFP-DD devices maintain an internal data word address counter containing the last address accessed during the latest read or write operation, incremented by one. The address counter is incremented whenever a data word is received or sent by the module. This address stays valid between operations as long as SFP-DD power is maintained. The address “roll over” during read and writes operations is from the last byte of the 128-byte memory page to the first byte of the same page.

### 2.3.2 Read Operation

#### 2.3.2.1 Current Address Read

A current address read operation requires only the device address read word (10100001) to be sent, see Figure 2.

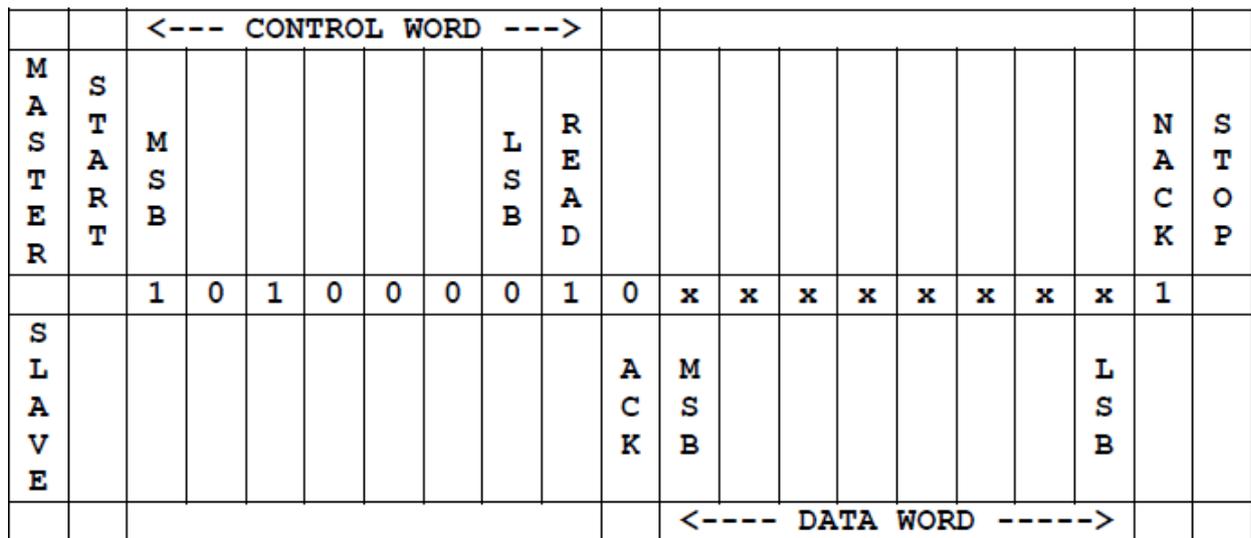


Figure 2: SFP-DD Current Address Read Operation

Once acknowledged by the SFP-DD, the current address data word is serially clocked out. The host does not respond with an acknowledgement, but does generate a STOP condition once the data word is read.

### 2.3.2.2 Random Read

A random read operation requires a “dummy” write operation to load in the target byte address as shown in Figure 3 below. This is accomplished by the following sequence.

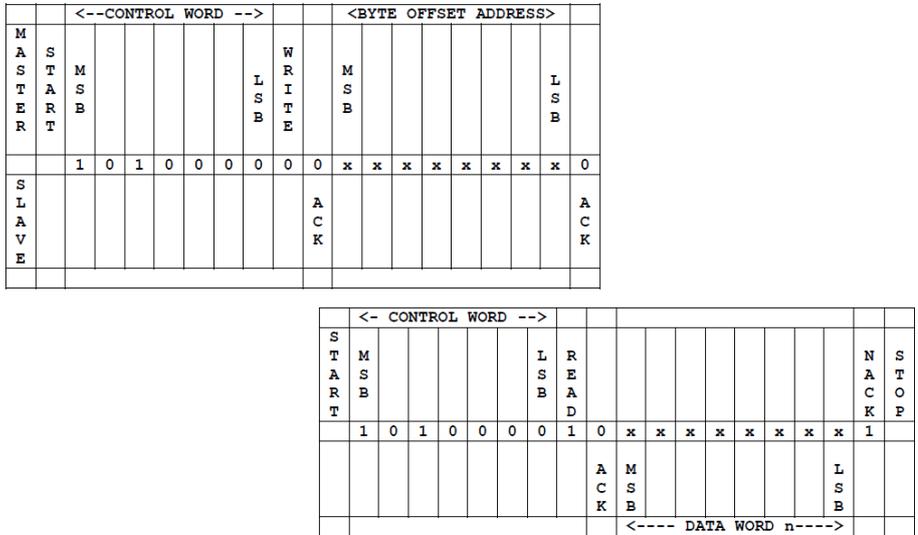


Figure 3: SFP-DD Random Read

The target 8-bit data word address is sent following the device address write word (10100000) and acknowledged by the SFP-DD. The host then generates another START condition (aborting the dummy write without incrementing the counter) and a current address read by sending a device read address (10100001). The SFP-DD acknowledges the device address and serially clocks out the requested data word. The host does not respond with an acknowledgement, but does generate a STOP condition once the data word is read.

### 2.3.2.3 Sequential Read

Sequential reads are initiated by a current address read (Figure 4) or a random address read (Figure 5). To specify a sequential read, the host responds with an acknowledgement (instead of a STOP) after each data word. As long as the SFP-DD receives an acknowledgement, it shall serially clock out sequential data words. The sequence is terminated when the host responds with a NACK and a STOP instead of an acknowledgement.



### 2.3.3 Write operation

A write operation requires an 8-bit data word address following the device address write word (10100000) and acknowledgement. Upon receipt of this address, the SFP-DD will again respond with a zero (ACK) to acknowledge and then clock in the first 8-bit data word. Following the receipt of the 8-bit data word, the SFP-DD will output a zero (ACK) and the Host must terminate the write sequence with a STOP condition for the write cycle to begin. If a START condition is sent in place of a STOP condition (repeated START) the write is aborted and the data received during that operation is discarded. Upon receipt of the proper STOP condition, the SFP-DD enters an internally timed write cycle to internal memory. The SFP-DD disables its management interface input during this write cycle and will not respond or acknowledge subsequent commands until the internal memory write is complete.

		<- CONTROL WORD -->								<BYTE OFFSET ADDRESS>								<- DATA WORD ->									
M A S T E R	S T A R T	M S B							L S B	W R I T E	M S B							L S B	M S B							L S B	S T O P
		1	0	1	0	0	0	0			0	0	x	x	x	X	x		x	x	x	0	x	x	x		
S L A V E									A C K								A C K								A C K		

Figure 6: SFP-DD Single Write Operation

#### 2.3.3.1 Sequential Write

Sequential byte write of up to eight bytes without repeatedly sending slave address and memory address information is supported. In a sequential write, the host should not include in the sequence a mixture of volatile and non-volatile registers.

A sequential write is initiated the same way as a single byte write, but the host master does not send a stop condition after the first word is clocked in. Instead, after the SFP-DD acknowledges receipt of the first data word, the Host can transmit additional data words: seven additional words for non-volatile memory or volatile memory. The SFP-DD will send acknowledge after each data word received.

The Host must terminate the sequential write sequence with a STOP condition.

Upon receipt of the proper Stop condition, the slave may enter an internally timed write cycle to internal memory. If there is no proper STOP condition, the results of the sequential write are unpredictable.

	<- CONTROL WORD -->									<BYTE OFFSET ADDRESS>								
M A S T E R	S T A R T	M S B							W R I T E	M S B								L S B
		1	0	1	0	0	0	0	0	x	x	x	x	x	x	x	x	0
S L A V E									A C K									A C K

M S B								L S B	M S B								L S B
	x	x	x	x	x	x	x	0	x	x	x	x	X	x	x	x	0
								A C K									A C K
<--- DATA WORD n --->									<--- DATA WORD n+1 --->								

M S B								L S B	M S B								L S B	S T O P
	x	x	x	x	x	x	x	0	x	x	x	x	x	x	x	x	0	
								A C K									A C K	
<--- DATA WORD n+2 --->									<--- DATA WORD n+x --->									

Figure 7: SFP-DD Sequential Write Operation

## 2.4 SFP-DD Memory Map

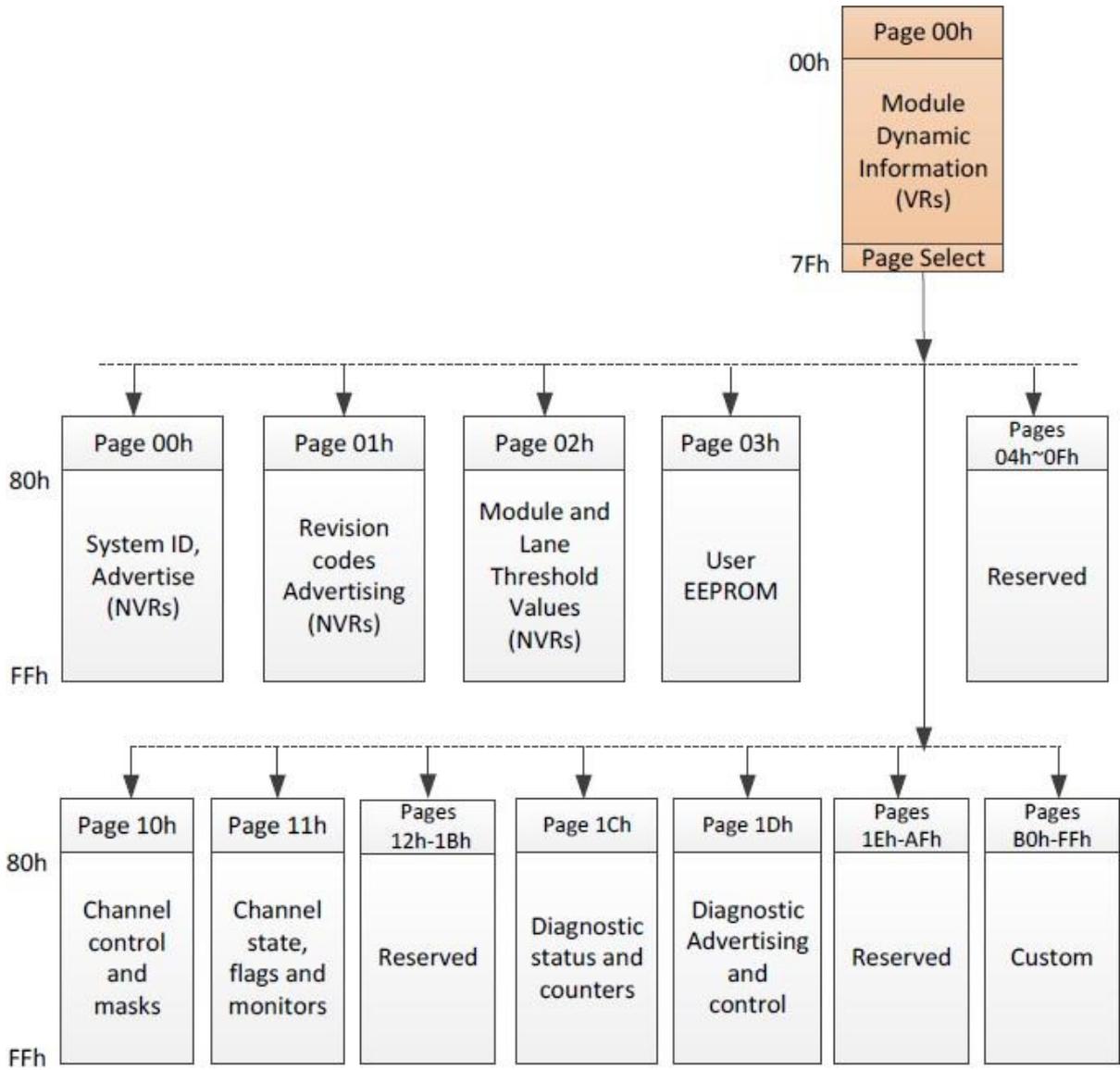


Figure 8: SFP-DD Memory Map

## 2.5 Low Speed Electrical Hardware Pins

In addition to the 2-wire serial interface the module has the following low speed pins for control and status:

- TxFault0, TxFault1
- TxDisable0, TxDisable1
- LPMode
- Speed0-1, Speed0-2, Speed1-1, Speed1-2
- RxLOS0, RxLOS1

### 2.5.1 TxFault0, TxFault1

TxFault0 and TxFault1 are module outputs, the ML4022-LB provides control functionality for those outputs by writing to bits 5~4 of register 143 (page 03).

Address	Bit	Name	Description	Type
143 (Page 03)	4	TxFault0 control bit	1b= TxFault0 set High 0b= TxFault0 set Low	RW
	5	TxFault1 control bit	1b= TxFault1 set High 0b= TxFault1 set Low	

### 2.5.2 TxDisable0, TxDisable1

TxDisable0 and TxDisable1 are module inputs from the Host, the digital state of those input signals can be checked via register 141 (Page 03) as shown below.

Address	Bit	Name	Description	Type
141 (Page 03)	0	TxDisable0	Digital State: Read 0b: signal is Low Read 1b: signal is High	RO
	1	TxDisable1		
	4	TxDisable0	Transition Detection: Read 0b: No edge detected Read 1b: Either rising or falling edges detected Write 0b: No effect Write 1b: Clear the register	
	5	TxDisable1		

### 2.5.3 LPMode

LPMode is an input signal to the module from the host operating with active high logic. The LPMode signal is pulled up to Vcc in the SFP-DD module. The LPMode signal intervenes in the Module State Transition (refer to section [2.6.2](#) for more details).

Address	Bit	Name	Description	Type
139 (Page 03)	0	LPMode	Digital State: Read 0b: signal is Low Read 1b: signal is High	RO
	4		Transition Detection: Read 0b: No edge detected Read 1b: Either rising or falling edges detected Write 0b: No effect Write 1b: Clear the register	

### 2.5.4 Speed0-1, Speed0-2, Speed1-1, Speed1-2

Speed0-1, Speed0-2, Speed1-1 and Speed1-2 are module inputs. Digital state of those signals can be checked via register 142 (Page 03).

Address	Bit	Name	Description	Type
142 (Page 03)	0	Speed0-1	Digital State: Read 0b: signal is Low Read 1b: signal is High	RO
	1	Speed0-2		
	2	Speed1-1		
	3	Speed1-2		
	4	Speed0-1	Transition detection: Read 0b: No edge detected Read 1b: Either rising or falling edges detected Write 0b: No effect Write 1b: Clear the register	
	5	Speed0-2		
	6	Speed1-1		
	7	Speed1-2		

## 2.5.5 RxLOS0, RxLOS1

RxLOS0 and RxLOS1 are module output signals.

These two signals could be controlled using two modes:

1. Following TxDisable state
2. Direct signal control

### 2.5.5.1 Following TxDisable

Address	Bit	Name	Description	Type
143 (Page 03)	0	RxLOS0 control source	1b= RXLOS0 follows digital state of TxDisable0 0b= RXLOS0 controlled directly through bit 1	RW
	2	RxLOS1 control source	1b= RXLOS1 follows digital state of TxDisable1 0b= RXLOS1 controlled directly through bit 3	

### 2.5.5.2 Direct Control

Address	Bit	Name	Description	Type
143 (Page 03)	1	RxLOS0 control bit	1b= RXLOS0 set high 0b= RXLOS0 set Low	RW
	3	RxLOS1 control bit	1b= RXLOS1 set high 0b= RXLOS1 set Low	

## 2.6 ML4022-LB Specific Functions

### 2.6.1 Module State

The Module State describes module-wide behaviors and properties. The ML4022-LB implements two module states: ModuleReady and ModuleLowPwr.

The ModuleLowPwr state is a host control state, where the management interface is fully initialized and operational and the device is in Low Power mode, the Led turns into Red and the PWM is deactivated. During this state, the host may configure the module using the management interface and memory map. The module state encoding for ModuleLowPwr is 001.

The ModuleReady state is a host control state that indicates that the module is in High Power mode, the Led turns into Green and the PWM is activated. The module state encoding for ModuleReady is 011.

Address	Bit	Name	Description	Type
<b>3 (lower Page)</b>	3~1	Module State	Current state of Module: 001b= ModuleLowPwr 011b= ModuleReady	RO

## 2.6.2 Module State Transition

The state transition between Low Power and High Power is related to three parameters:

1. ForceLowPwr bit– software control (forces module into low power mode), register 26 bit4
2. LowPwr bit – software control, register 26 bit 6
3. LPMode – Hardware signal

According to these parameters, the state of the module is defined. Conditions for Low Power and High Power state, are summarized in the table below.

ForceLowPwr ( Reg 26 bit 4)	LowPwr (register 26 bit 6)	LPMode	State
1	X	X	Low Power
0	1	1	Low Power
0	1	0	High Power
0	0	1	High Power
0	0	0	High Power

## 2.6.3 Module Global Controls

Module global controls are control aspects that are applicable to the entire module or all channels in the module.

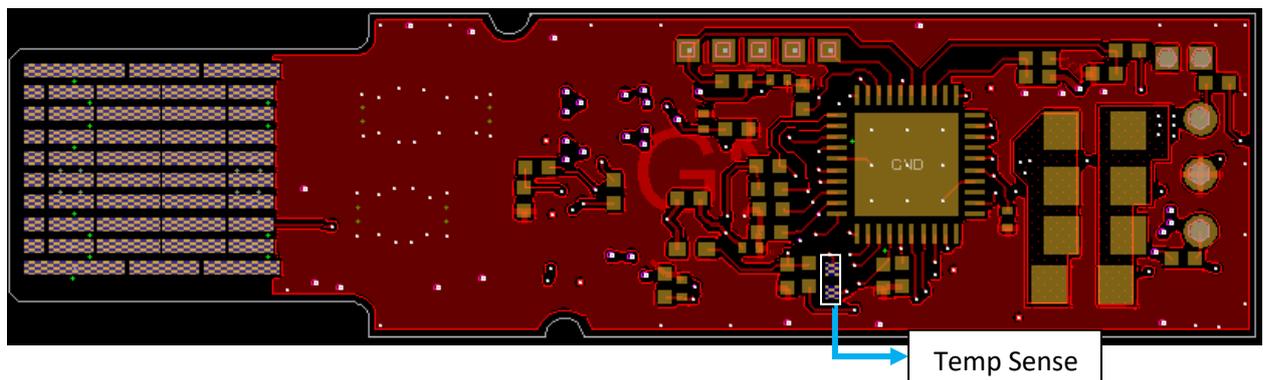
Address	Bit	Name	Description	Type
<b>26(lower Page)</b>	6	LowPwr	Parameter used to control the module power mode (refer to section <a href="#">2.6.2</a> ) Default value =1	
	4	ForceLowPwr	0b= high power mode(default) 1b=Forces module into low power mode	RW

	3	Software Reset	Self-clearing bit that causes the module to be reset. The effect is the same as asserting the reset pin for the appropriate hold time, followed by its de-assertion. This bit will be cleared to zero on a reset so a value of 0 will always be returned. 0b=not in reset 1b=Software reset	
<b>3(lower page)</b>	0	Software Interrupt	Digital state of Interrupt: 0b= Interrupt source is present 1b= No interrupt source present	RO

### 2.6.4 Temperature Monitor

The ML4022-LB has an internal temperature sensor in order to continuously monitor the module temperature. The temperature sensor readings are present in low-memory registers 14-15. Internally measured Module temperature are represented as a 16-bit signed two’s complement value in increments of 1/256 degrees Celsius, yielding a total range of –128C to +128C that is considered valid between –40 and +125C. Temperature accuracy is less than 1 degree Celsius over specified operating temperature and voltage. The location of the temperature sensor is shown below.

Address	Bit	Name	Description
<b>14 (lower Page)</b>	ALL	Temperature MSB	Internally measured module temperature
<b>15 (lower Page)</b>	ALL	Temperature LSB	Internally measured module temperature



The temperature Alarms and warnings interrupt flags exists in lower page.

Address	Bit	Name	Description
<b>9 (lower Page)</b>	3	L-Temp Low Warning	Latched low temperature warning flag
	2	L-Temp High Warning	Latched high temperature warning flag
	1	L-Temp Low Alarm	Latched low temperature alarm flag
	0	L-Temp High Alarm	Latched high temperature alarm flag

Note that any interrupt flag when asserted will generate the interrupt. Its state is read from register 3 bit 0 (refer to the table in section [2.6.3](#)).

### 2.6.5 Programmable Power Dissipation & Thermal Emulation

Registers 135, 136, 137 and 138, page 03h are used for PWM control over I2C. They are 8 bits data wide registers.

The consumed power changes accordingly when the values of these registers are changed (only in high power mode). In Low power mode the module automatically turns off PWM. The values written in these registers are permanently stored.

The PWM can also be used for module thermal emulation.

The module contains 4 thermal spots positioned where the optical transceivers usually are in an optical module that is heated relative to the related PWM register. Each spot is 1.08W, where two of them (spot 1 and 3) could be increased to 1.4W by populating an additional resistor for each spot to get an overall power consumption of 4.96W.

Programmable power can be controlled using PWM, thus allowing a power consumption that covers all the range from 0 to 4.32W with 4.2mW resolution.

(Note that if spots 1 and 3 are modified to dissipate 1.4W, the overall power consumption reaches 4.96W and the resolution of these two spots will be around 5.4mW).

Note that these values are the NET spots consumption, where the module components dissipate around 0.14W, which is added to spots power to get total module consumption.

Address	Bit	Name	Description
<b>135 (Page 03)</b>	7:0	PWM controller 1	1.08W Top power spot control register, powered by VccR net ( <b>corresponding spot could be modified to 1.4W</b> )
<b>136 (Page 03)</b>	7:0	PWM controller 2	1.08W Top power spot control register, powered by VccT net
<b>137 (Page 03)</b>	7:0	PWM controller 3	1.08W Bottom power spot control register, powered by VccR net ( <b>corresponding spot could be modified to 1.4W</b> )
<b>138 (Page 03)</b>	7:0	PWM controller 4	1.08W Top power spot control register, powered by VccT net

In the figure below, the red spots represent the thermal spots on the module.

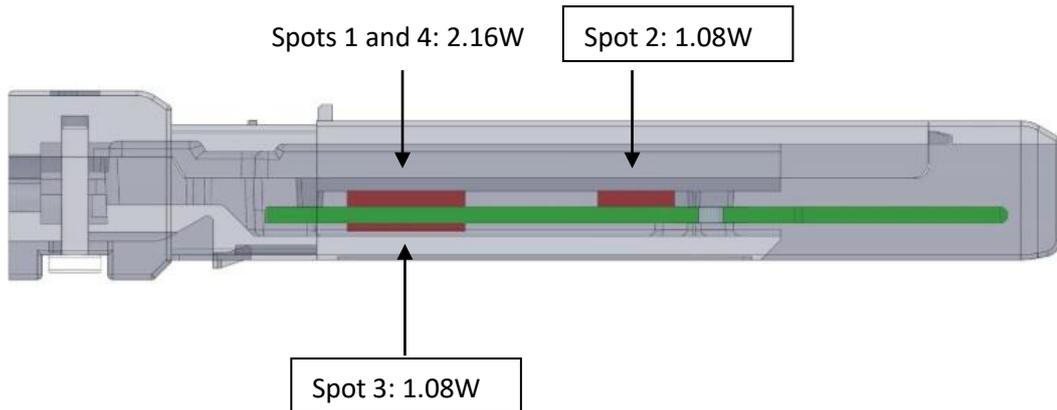


Figure 9: Power Spots Location

### 2.6.6 Cut-Off Temperature

To avoid overheating the module, a Cut-Off Temperature is pre-defined.

The module is continuously monitoring the temperature and checking its value against the Cut-Off temperature. Once the module reaches the cut-off temperature, the PWM will automatically turn off in order to prevent overheating. Once the temperature is 5 degrees below cut-off value, the PWM turns on again with the same previous values.

The Cut-Off temperature for the ML4022-LB is 85 DegC and it can be programmed to any value from register 134 of memory page03. Maximum cut-off temperature is 90 DegC.

Address	Bit	Name	Description	Type
<b>134 (Page 03)</b>	7:0	Cut-Off temperature	Module Cut-Off Temperature, LSB = 1 degC	RW

### 2.6.7 Voltage Sense

The ML4022-LB features two voltage sense circuits that allow measuring of internal module voltages VccT and VccR. Measured values range from 0 to 6.55V. LSB unit is 100uV.

Address	Bit	Name	Description
<b>16 (lower Page)</b>	ALL	VccR MSB	Internally measured module VccR
<b>17 (lower Page)</b>	ALL	VccR LSB	Internally measured module VccR
<b>22 (lower Page)</b>	ALL	VccT MSB	Internally measured module VccT
<b>23 (lower Page)</b>	ALL	VccT LSB	Internally measured module VccT

The Voltage Alarms and warnings interrupt flags exists in lower page.

Address	Bit	Name	Description
<b>9 (lower Page)</b>	7	L-VCCR Low Warning	Latched low supply voltage warning flag
	6	L-VCCR High Warning	Latched low supply voltage warning flag
	5	L-VCCR Low Alarm	Latched low supply voltage alarm flag
	4	L-VCCR High Alarm	Latched low supply voltage alarm flag

Address	Bit	Name	Description
<b>11 (lower Page)</b>	3	L-VCCT Low Warning	Latched low supply voltage warning flag
	2	L-VCCT High Warning	Latched low supply voltage warning flag
	1	L-VCCT Low Alarm	Latched low supply voltage alarm flag
	0	L-VCCT High Alarm	Latched low supply voltage alarm flag

### 2.6.8 Insertion Counter

The Insertion counter contains the number of times the module was plugged in a host. The insertion counter is incremented every time the module goes in initializing sequence, as it is nonvolatile it is always saved. The insertion counter can be read from registers 132-133 page03.

Address	Bit	Name	Description
<b>132 (page 03)</b>	MSB	Insertion Counter MSB	
<b>133 (page 03)</b>	LSB	Insertion Counter LSB	LSB unit = 1 insertion

### 2.6.9 Alarm and Warning Thresholds

Each A/D quantity has a corresponding high alarm, low alarm, high warning and low warning threshold. These factory preset values allow the user to determine when a particular value is exceeding the predefined limit. While Voltage LSB unit is 100  $\mu$ V and Temperature LSB unit is 1/256  $^{\circ}$ C. Note that these addresses are of memory Page 02.

Address	Bit	Name	Default Value	Type
<b>128(Page 02)</b>	ALL	high temp alarm threshold (MSB)	80 $^{\circ}$ C	RW
<b>129(Page 02)</b>	ALL	high temp alarm threshold (LSB)		
<b>130(Page 02)</b>	ALL	low temp alarm threshold (MSB)	0 $^{\circ}$ C	
<b>131(Page 02)</b>	ALL	low temp alarm threshold (LSB)		

<b>132(Page 02)</b>	ALL	high temp warning threshold (MSB)	75°C	
<b>133(Page 02)</b>	ALL	high temp warning threshold (LSB)		
<b>134(Page 02)</b>	ALL	low temp warning threshold (MSB)	5°C	
<b>135(Page 02)</b>	ALL	low temp warning threshold (LSB)		
<b>136(Page 02)</b>	ALL	high volt alarm threshold (MSB)	3.6 V	
<b>137(Page 02)</b>	ALL	high volt alarm threshold (LSB)		
<b>138(Page 2)</b>	ALL	low volt alarm threshold (MSB)	3.0 V	
<b>139(Page 2)</b>	ALL	low volt alarm threshold (LSB)		
<b>140(Page 2)</b>	ALL	high volt warning threshold (MSB)	3.55 V	
<b>141(Page 2)</b>	ALL	high volt warning threshold (LSB)		
<b>142(Page 2)</b>	ALL	low volt warning threshold (MSB)	3.05 V	
<b>143(Page 2)</b>	ALL	low volt warning threshold (LSB)		

### 2.6.10 FW and HW Revision

Information about the FW and HW revision are present in lower page registers 39 and 40, and in Page 01, registers 130 and 131 as described in the table below.

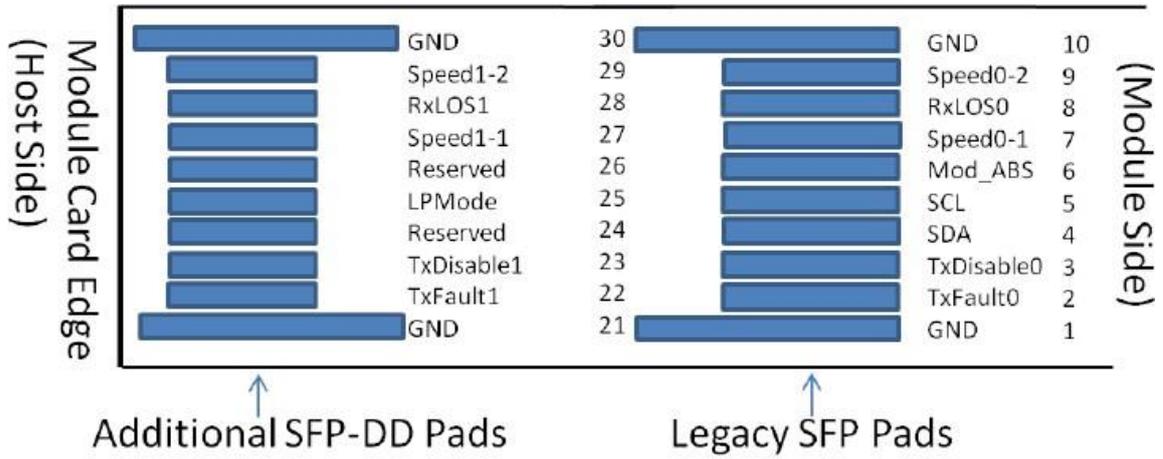
Address	Bit	Description	Type
<b>39 (Lower Page)</b>	All	Major FW Rev	RO
<b>40 (Lower Page)</b>	All	Minor FW Rev	
<b>130 (page 01)</b>	All	Major HW Rev	
<b>131 (page 01)</b>	All	Minor HW Rev	

## 3. High Speed Signals

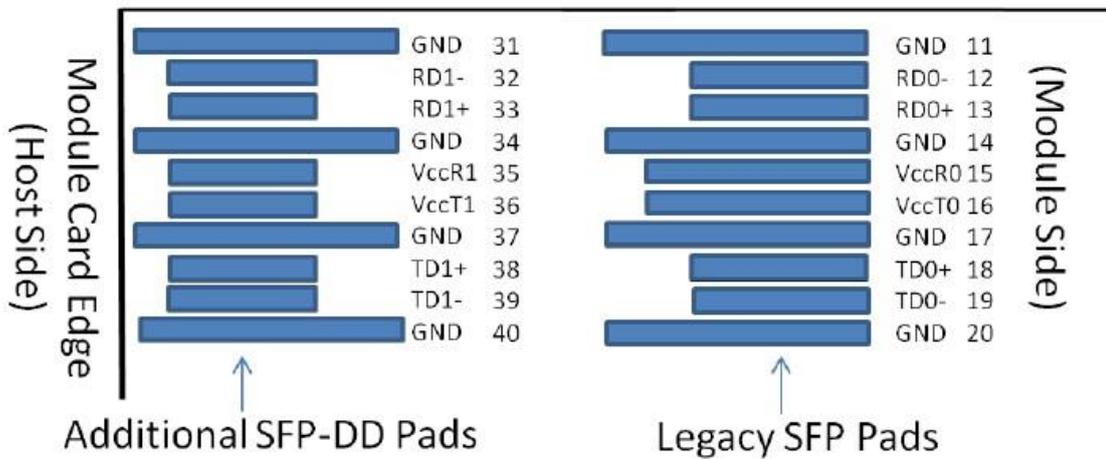
SFP-DD supports two lanes; TX0/RX0 and TX1/RX1. High speed signals are electrically looped back from TX side to RX side of the module, every differential TX pair is connected to its corresponding RX pair, and the signals are AC coupled as specified by SFP-DD MSA HW specs.

The Passive traces connecting TX to RX pairs are designed to support a data rate up to 28Gbaud (56Gbps).

## 4. ML4022-LB Pin Allocation



Bottom side as viewed from top thru board



Top side viewed from top of board

Figure 10: Module Pad Layout

## Revision History

Revision number	Date	Description
0.1	6/10/2019	<ul style="list-style-type: none"><li>▪ Preliminary</li></ul>
0.2	7/23/2019	<ul style="list-style-type: none"><li>▪ Correct description of low speed electrical hardware pins</li></ul>
0.3	8/13/2019	<ul style="list-style-type: none"><li>▪ Section 2.6.5: Correct the values of power dissipation and the description in the table</li><li>▪ Section 2.6.2: Update description of the three parameters</li></ul>

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